AUTOMOTIVE

ROHS

HALOGEN

FREE



Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



SlimSMA (DO-221AC)



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS			
I _{F(AV)}	3.0 A		
V_{RRM}	45 V		
I _{FSM}	80 A		
I_R at $V_R = 45 \text{ V } (125 \text{ °C})$	5 mA		
V _F at I _F = 3.0 A (125 °C)	0.37 V		
T _J max.	150 °C		
Package	SlimSMA (DO-221AC)		
Circuit configuration	Single		

FEATURES

- Very low profile typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- · Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base $P/NHM3_X$ - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	VSSAF3L45	UNIT	
Device marking code		3L45		
Maximum repetitive peak reverse voltage	V _{RRM}	45	V	
Maximum DC forward rectified current	I _{F(AV)} (1)	3.0	А	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	I _{FSM} 80		
Operating junction and storage temperature range	T _J ⁽²⁾ , T _{STG}	-40 to +150	°C	

Note

- (1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB
- $^{(2)}$ The heat generated must be less than thermal conductivity from junction to ambient: $dP_D/DT_J < 1/R_{\theta JA}$



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.5 A	1	V _F ⁽¹⁾	0.41	-	V
	$I_F = 3.0 \text{ A}$			0.46	0.54	
	I _F = 1.5 A	T _A = 125 °C		0.31	-	
	I _F = 3.0 A			0.37	0.46	
Reverse current	V _R = 45 V	T _A = 25 °C	$T_A = 25 ^{\circ}\text{C}$ $T_A = 125 ^{\circ}\text{C}$ $I_R^{(2)}$	-	450	μΑ
	v _R = 45 v	$T_A = 45 \text{ °C}$		5	25	mA
Typical junction capacitance	4.0 V, 1 MHz		CJ	425	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)				
PARAMETER	SYMBOL VSSAF3L45		UNIT	
Typical thermal resistance	R ₀ JA (1)(2)	115	°C/W	
Typical thermal resistance	R _{0JM} (2)(3)	12		

Notes

- $^{(1)}\,$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- (2) The heat generated must be less than thermal conductivity from junction to ambient: $dP_D/DT_J < 1/R_{\theta,JA}$
- $^{(3)}$ Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB, $R_{\theta JM}$ junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSSAF3L45-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel	
VSSAF3L45-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel	
VSSAF3L45HM3_A/H (1)	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF3L45HM3_A/I (1)	0.032	I	14 000	13" diameter plastic tape and reel	

Note

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)

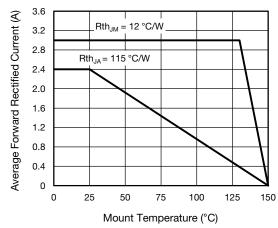


Fig. 1 - Maximum Forward Current Derating Curve

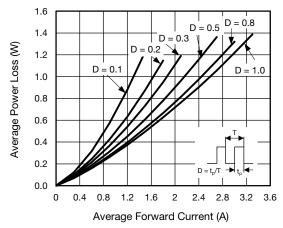


Fig. 2 - Average Power Loss Characteristics

⁽¹⁾ AEC-Q101 qualified



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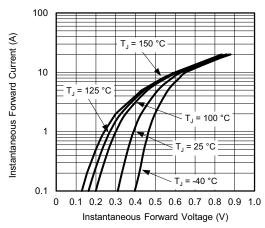


Fig. 3 - Typical Instantaneous Forward Characteristics

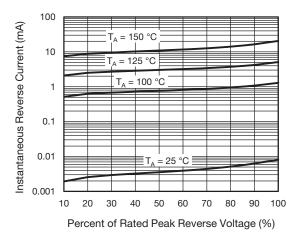


Fig. 4 - Typical Reverse Leakage Characteristics

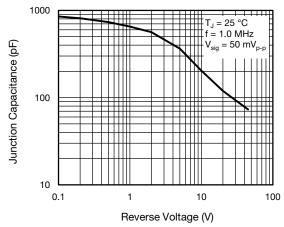


Fig. 5 - Typical Junction Capacitance

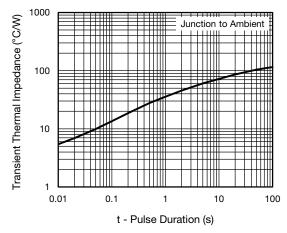


Fig. 6 - Typical Transient Thermal Impedance

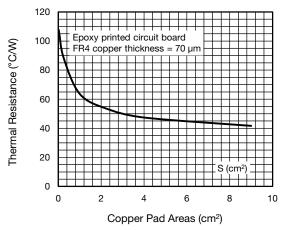


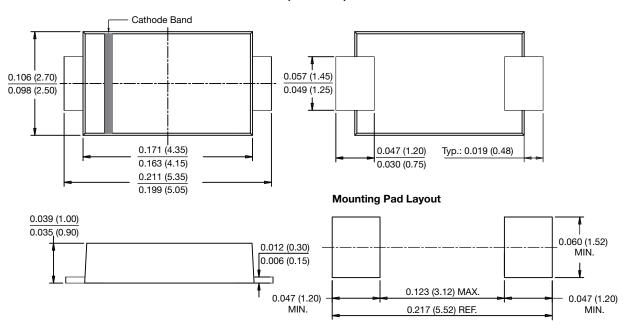
Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMA (DO-221AC)





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